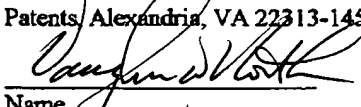


**BEST AVAILABLE COPY**PATENT APPLICATION  
DOCKET NO. 10007804-1**IN THE UNITED STATES PATENT AND TRADEMARK OFFICE**

<b>APPLICANT:</b>	Huei Pei Kuo, et. al.	<b>CERTIFICATE OF DEPOSIT UNDER 37 C.F.R. § 1.8</b>  I hereby certify that this correspondence is being deposited with the United States Postal Service as First Class Mail, postage prepaid, under 37 C.F.R. § 1.8 on the date indicated below and is addressed to Commissioner for Patents, Alexandria, VA 22313-1450.   Name  <u>Nov 10, 05</u> Date of Deposit
<b>SERIAL NO.:</b>	10/656,635	
<b>FILED:</b>	September 4, 2003	
<b>FOR:</b>	ANODIZING PROCESS FOR IMPROVING ELECTRONIC EMISSION IN ELECTRONIC DEVICES	
<b>ART UNIT:</b>	2811	
<b>EXAMINER:</b>	Hu, Shouxiong.	
<b>DOCKET NO.:</b>	10007804-1	

**DECLARATION OF PAUL J. BENNING  
UNDER 37 C.F.R. § 1.132**

Mail Stop Amendment  
Commissioner for Patents  
P.O. Box 1450  
Alexandria, VA 22313-1450

I, Paul J. Benning declare as follows:

1. It is my understanding that various claims in the above-recited patent application have been rejected in view of United States Patent Application Publication 2003/0143788 A1, filed January 31, 2002, and entitled "Method of Manufacturing an Emitter."

2. I am a named inventor in United States Patent Application Publication

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2003/0143788.

3. Information concerning the invention as described and claimed in the above-referenced Patent Application Serial Number 10/656,635 was communicated to me by Huei Pei Kuo and Xia Sheng through our common association as employees of Hewlett Packard Company during a series of in person meetings and teleconferences in the Spring and early Summer of 2001. These communications included a description of the silicon anodization technique and supporting process, and the design of an electron emitting device and variations thereof produced with the anodization process.

5. I declare that all statements made herein of my own knowledge are true and that all statements made on information and belief are believed to be true, and further that these statements were made with the knowledge that willful, false statements and the like so made are punishable by fine or imprisonment, or both, under Section 1001 of Title 18 of the United States Code, and that such willful, false statement may jeopardize the validity of the application or any patent issuing thereon.

DATED this 31 day of October, 2005.

Paul J. Benning